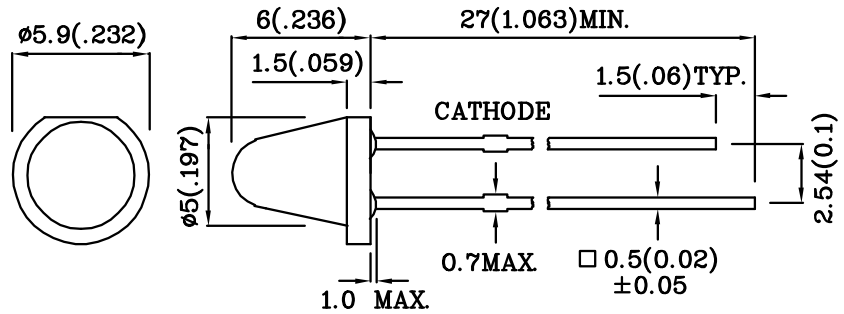


Features

- LOW PROFILE.
- LOW POWER CONSUMPTION.
- LONG LIFE - SOLID STATE RELIABILITY.
- RELIABLE AND RUGGED.
- RoHS COMPLIANT.



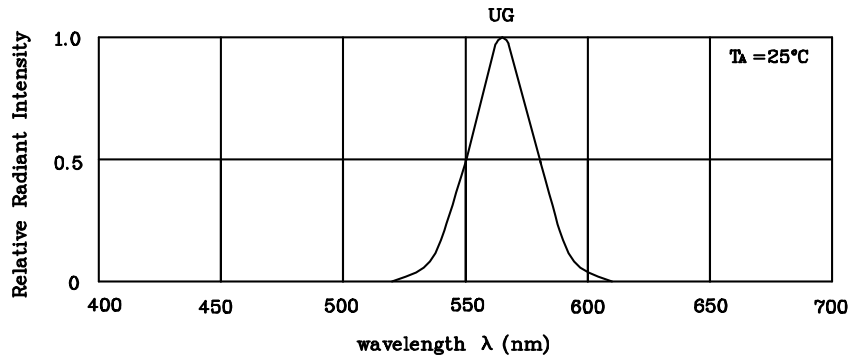
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.

Absolute Maximum Ratings (TA=25°C)		UG (GaP)	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA
Power Dissipation	PT	105	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds		
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds		

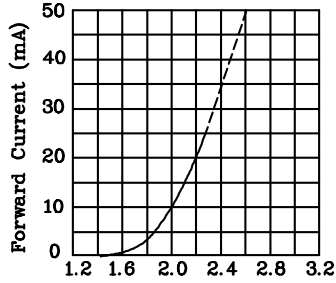
Operating Characteristics (TA=25°C)		UG (GaP)	Unit
Forward Voltage (Typ.) (IF=10mA)	VF	2.0	V
Forward Voltage (Max.) (IF=10mA)	VF	2.5	V
Reverse Current (VR=5V)	IR	10	uA
Wavelength of Peak Emission (IF=10mA)	λ peak	565	nm
Wavelength of Dominant Emission (IF=10mA)	λ D	568	nm
Spectral Line Full Width At Half-Maximum (IF=10mA)	$\Delta\lambda$	30	nm
Capacitance (VF=0V, f=1MHz)	C	15	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=10mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
XLUG56C	Green	GaP	Green Transparent	18	39	565	30°
Published Date : MAY.22.2005 Drawing No : XDSA2414 V3 Checked : B.L.LIU P.1/3							

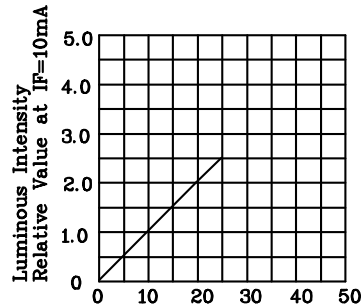


RELATIVE INTENSITY Vs. WAVELENGTH

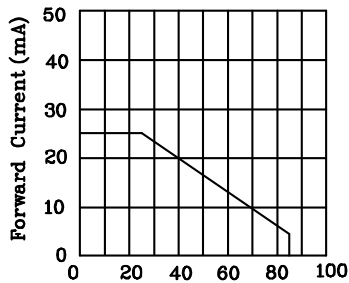
❖ UG



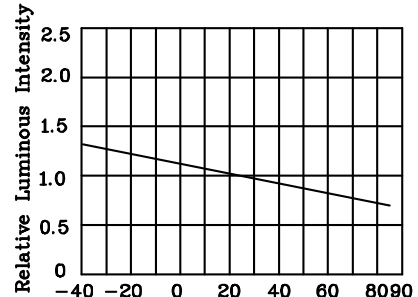
Forward Voltage(V)
 FORWARD CURRENT Vs.
 FORWARD VOLTAGE



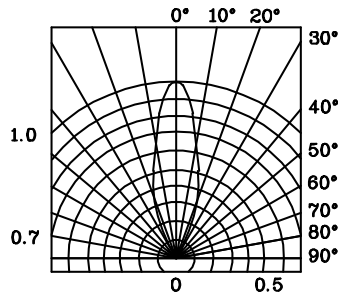
LUMINOUS INTENSITY Vs.
 FORWARD CURRENT



Ambient Temperature $T_A(^{\circ}\text{C})$
 FORWARD CURRENT
 DERATING CURVE



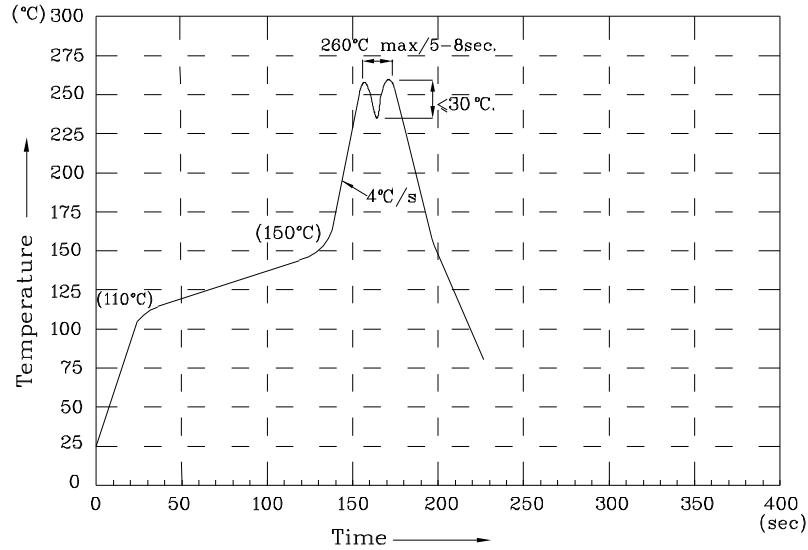
LUMINOUS INTENSITY Vs.
 AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

XLUG56C

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85 degree°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.